SOT-23 Plastic-Encapsulate MOSFETS

Features

- V_{DS}= -20V
- I_D= -3.3A
- $R_{DS(on)}$@V_{GS}=-4.5V ＜ 64mΩ
- $R_{DS(on)}$@V_{GS}=-2.5V ＜ 80mΩ
- Trench Power MV MOSFET technology
- Voltage controlled small signal switch
- Fast Switching Speed

Drain-source Voltage
-20 V
Drain Current
-3.3 Ampere

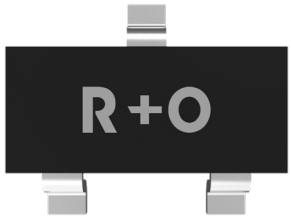
Applications

- Battery operated systems
- Solid-state relays
- Direct logic-level interface：TTL/CMOS

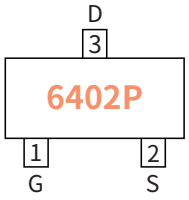
Mechanical Data

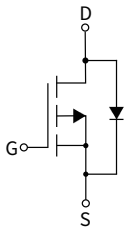
- Case: SOT-23
  Molding compound meets UL 94V-0 flammability rating, RoHS-compliant,halogen-free
- Terminals: Solder plated, solderable per MIL-STD-750,Method 2026

SOT-23



Function Diagram





Ordering Information

PACKAGE	PACKAGE CODE	UNIT WEIGHT(g)	REEL(pcs)	BOX(pcs)	CARTON(pcs)	DELIVERY MODE
SOT-23	R1	0.008	3000	30000	180000	7''

Maximum Ratings (Ta=25°C Unless otherwise specified)

PARAMETER		SYMBOL	UNIT	VALUE
Drain-source Voltage		V_{DS}	V	-20
Gate-source Voltage		V_{GS}	V	±10
Drain Current	T_A=25°C @ Steady State	I_D	A	-3.3
Pulsed Drain Current		I_{DM}	A	-13
Total Power Dissipation @ T_A=25°C		P_D	W	1.0
Thermal Resistance Junction-to-Ambient @ Steady State		$R_{\theta JA}$	°C / W	125
Junction and Storage Temperature Range		T_J,T_{STG}	°C	-55 ~+150

Static Parameter Characteristics (Ta=25°C Unless otherwise specified)

PARAMETER	SYMBOL	Condition	UNIT	Min	Typ	Max
Drain-Source Breakdown Voltage	BV_{DSS}	V_{GS}= 0V, I_D= -250μA	V	-20	—	—
Zero Gate Voltage Drain Current	I_{DSS}	V_{DS}= -20V,V_{GS}=0V	μA	—	—	-1.0
Gate-Body Leakage Current	I_{GSS}	V_{GS}= ±10V, V_{DS}=0V	nA	—	—	±100
Gate Threshold Voltage	$V_{GS(th)}$	V_{DS}= V_{GS}, I_D= -250μA	V	-0.4	-0.62	-1.0
Static Drain-Source On-Resistance	$R_{DS(ON)}$	V_{GS}= -4.5V, I_D= -3.3A	mΩ	—	49	64
		V_{GS}= -2.5V, I_D= -3.0A		—	59	80
		V_{GS}= -1.8V, I_D= -2.5A		—	79	110

Dynamic Parameters (Ta=25°C Unless otherwise specified)

PARAMETER	SYMBOL	Condition	UNIT	Min	Typ	Max
Input Capacitance	C_{iss}	V_{DS}=-10V V_{GS}=0V f=1MHZ	pF	—	490	—
Output Capacitance	C_{oss}			—	85	—
Reverse Transfer Capacitance	C_{rss}			—	66	—

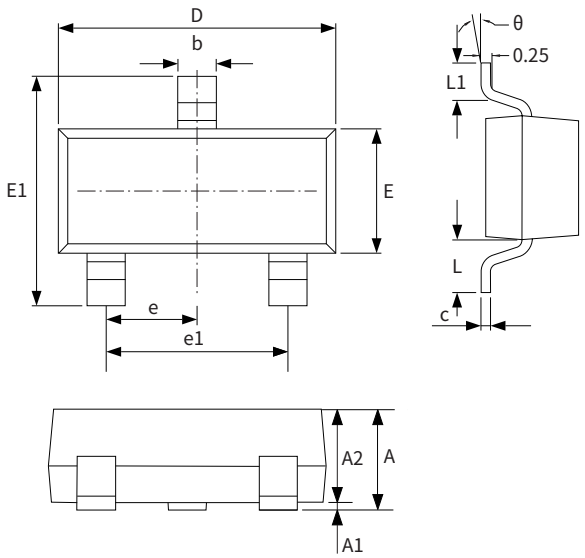
Switching Parameters (Ta=25°C Unless otherwise specified)

PARAMETER	SYMBOL	Condition	UNIT	Min	Typ	Max
Total Gate Charge	Q_g	V_{GS}=-4.5V V_{DS}=-10V I_D=-2.0A	nC	—	5.4	—
Gate-Source Charge	Q_{gs}			—	1.2	—
Gate-Drain Charge	Q_{gd}			—	1.2	—
Turn-on Delay Time	$t_{D(on)}$	V_{DD}=-10V V_{GEN}=-4.5V R_G=2.5Ω I_D=-1.0A	nS	—	7	—
Turn-on Rise Time	t_r			—	22	—
Turn-off Delay Time	$t_{D(off)}$			—	38	—
Turn-off fall Time	t_f			—	35	—

Drian-Source Diode Characteristics

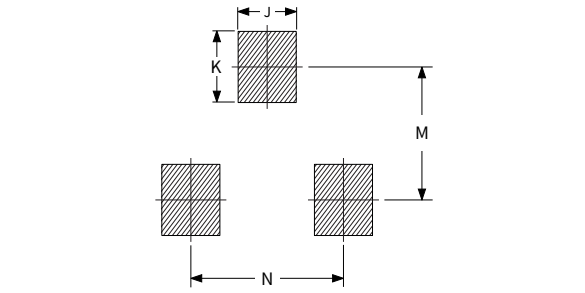
PARAMETER	SYMBOL	Condition	UNIT	Min	Typ	Max
Diode Forward Voltage	V_{SD}	I_S=-3.3A, V_{GS}=0V	V	—	—	-1.2
Maximum Body-Diode Continuous Current	I_S	—	A	—	—	-3.3

Package Outline Dimensions (SOT-23)



Symbol	Dimensions			
	Millimeters		Inches	
	Min.	Max.	Min.	Max.
A	0.90	1.15	0.035	0.045
A1	-	0.10	-	0.004
A2	0.90	1.05	0.035	0.041
b	0.30	0.50	0.012	0.020
c	0.10	0.20	0.004	0.008
D	2.80	3.00	0.110	0.118
E	1.20	1.40	0.047	0.055
E1	2.25	2.55	0.089	0.100
e	0.950TYP		0.037TYP	
e1	1.80	2.00	0.071	0.079
L	0.550REF		0.022REF	
L1	0.30	0.50	0.012	0.020
θ	-	8°	-	8°

Suggested Pad Layout



Symbol	Dimensions			
	Millimeters		Inches	
	Min.	Max.	Min.	Max.
J	0.80	-	0.031	-
K	-	0.90	-	0.035
M	2.00	-	0.078	-
N	-	1.90	-	0.074